

C0603X561J5GACTU

Aliases (C0603X561J5GAC7867) SMD Comm COG Flex, Ceramic, 560 pF, 5%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 0603, 0.4 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Sp
Chip Size	0603	Ca
L	1.6mm +/-0.17mm	Me
W	0.8mm +/-0.15mm	То
т	0.8mm +/-0.15mm	Vo
S	0.4mm MIN	Die
В	0.45mm +/-0.15mm	Te
		т.

Packaging Specifications Packaging

Packaging Quantity

> T&R, 180mm, Paper Tape 4000

Specifications	
Capacitance	560 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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